



Module | Team Mac Series

Team Mac (DDR3 1600/1333/1066)



Team Mac SO-DIMM is not only completely compatible with the Mac operating system, also passed Mac verifications, completely solving the troublesome compatibility problems for Mac users. Team Mac inherited Team Group's standard persistence for quality, and uses memory particles rigorously selected and tested by Team Group to guarantee optimal and excellent operating performances. In addition, Team Mac memory modules are made of single channel and dual channels, with capacities ranging from 2GB~8GB to satisfy users'unlimited demand for upgrading!

The all new Team Mac SO-DIMM memory modules also break the mainstream rules by adopting heat-sinks on the SO-DIMM to protect the chip from collision. The heat skin can also help disperse heat more efficiently, providing a more stable operating environment. It uses aluminum to create a super lightweight case, which delicately compliments with the design of Macbook / Macbook Pro. The Team Mac SO-DIMM takes the lead in bringing memory modules into a new lightweight trend!



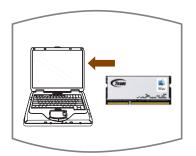
Main Feature

- □ Larger capacity: 2GB / 4GB / 8GB
- $\hfill\square$ Faster speed: DDR3-1600 \hfiln DDR3-1333 $\hfiln DDR3-1066$
- $\hfill\square$ Greater performance: MAXIMUM COMPUTING SPEED UP TO 12,800MHZ
- $\hfill\square$ Energy saving: 1.5V / 1.35V
- $\hfill\square$ Superb cooling: Heatsink with excellent cooling performance

Specification

Item	Specification	
PC type	Notebook	
Module specification	204 Pin SO DIMM Non ECC	
Die layout	128x8 / 256x8 / 512x8	
Capacity	2GB / 4GB / 8GB	
Data transfer bandwidth	8,528 MB / Sec (PC3 8500) DDR3-1066	
	10,664 MB / Sec (PC3 10600) DDR3-1333	
	12,800 MB / Sec (PC3 12800) DDR3-1600	
CL-value	7-7-7-21 / 9-9-9-24 / 11-11-11-28	
Working voltage	1.5V / 1.35V	
PCB structure	8 Layer PCB	
Extra features	Aluminum heat-sink (According to the	
	actual products)	
Warranty	Lifetime warranty	







Ordering Information

Team P/N	Capacity	Description
TMD32G1066HC9-S01	2GB	PC8500 DDR3 1066MHz CL7-7-7-21
TMD34G1066HC9-S01	4GB	PC8500 DDR3 1066MHz CL7-7-7-21
TMD34G1333HC9-S01	4GB	PC10600 DDR3 1333MHz CL9-9-9-24
TMD3L4G1333HC9-S01	4GB	PC10600 DDR3 1333MHz CL9-9-9-24
TMD38G1333HC9-S01	8GB	PC10600 DDR3 1333MHz CL9-9-9-24
TMD3L8G1333HC9-S01	8GB	PC10600 DDR3 1333MHz CL9-9-9-24
TMD34G1600HC11-S01	4GB	PC12800 DDR3 1600MHz CL11-11-11-28
TMD3L4G1600HC11-S01	4GB	PC12800 DDR3 1600MHz CL11-11-11-28
TMD38G1600HC11-S01	8GB	PC12800 DDR3 1600MHz CL11-11-11-28
TMD3L8G1600HC11-S01	8GB	PC12800 DDR3 1600MHz CL11-11-11-28

Above technical information is based on industry standard data and tested to be reliable. However, Team makes no warranty, either expressed or implied, as to its accuracy and assumes no liability in connection with the use of this product.

Team reserves the right to make changes in specifications at any time without prior notice.



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